ABBOGIATION CONNECTING ELECTRONICS INDUSTRIES OF INTERNATIONAL AND A	IPC. Bannockt	ourn. Illinois. A	ll rights reserved un ntions.	nder both	This docum level parts, t	ent is a declaration en	n of the substar compasses all le	ces within the manufactu ower level materials for w	rer listed ite which the ma	em. Note: if anufacturer	the item is an as has engineering	sembly with lower responsibility.	
				Form Type Distribute						on			
Supplier Information													
Company name* Company un			inique ID			Unique ID Authority				Response Date*			
onsemi								2025-05-13					
ontact Name Title - Contact				Phone - Contact*			Email - Contact*						
Product-Env-Stewards Product Enviro			iro Compliance		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Represe			esentative		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product E			duct Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	Manufacturing Site		/eight*	UOM	Unit Type	
	MM3Z4	MM3Z4V3C 4.3V 0.2W 5% Z		en SOD323F		2025-05-13 CN2		4	58939	mg	Each		
Manufacturing Proccess Informa	ntion							-					
Terminal Plating / Grid Array M	laterial 7	rial Terminal Base Alloy		-STD-020 MSI	Rating	Peak Proce	ak Process Body Temperature Max Time at Peak		Temperatu	re Numbe	er of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy		1	1		260	С	30	second	s 3				
Comments													
evel 1 - maximum time at peak temperat	ure during sol	ldering is 10-3	0 seconds										
or more information regarding materia	l composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.0285	mg
			Supplier	Gold (Au)	7440-57-5		0.0014	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0001	mg
Lead Frame	1.004	mg	Supplier	Silver (Ag)	7440-22-4		0.004	mg
			Supplier	Chromium (Cr)	7440-47-3		0.002	mg
			Supplier	Manganese (Mn)	7439-96-5		0.008	mg
			В	Nickel (Ni)	7440-02-0		0.41	mg
			Supplier	Iron (Fe)	7439-89-6		0.58	mg
Mold Compound-Black	3.44999	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.3736	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0186	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		2.7179	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.3398	mg
Plating	0.1	mg	Supplier	Tin (Sn)	7440-31-5		0.1	mg
Wire Bond - Cu	0.0054	mg	Supplier	Copper (Cu)	7440-50-8		0.0054	mg